DS05-11035-2E

MEMORY CMOS

2 × 1 M × 8 BIT SYNCHRONOUS DYNAMIC RAM

MB81F16822B-75/-102/-103

CMOS 2-Bank \times 1,048,576-Word \times 8 Bit Synchronous Dynamic Random Access Memory

■ DESCRIPTION

The Fujitsu MB81F16822B is a CMOS Synchronous Dynamic Random Access Memory (SDRAM) containing 16,777,216 memory cells accessible in an 8-bit format. The MB81F16822B features a fully synchronous operation referenced to a positive edge clock whereby all operations are synchronized at a clock input which enables high performance and simple user interface coexistence. The MB81F16822B SDRAM is designed to reduce the complexity of using a standard dynamic RAM (DRAM) which requires many control signal timing constraints, and may improve data bandwidth of memory as much as 5 times more than a standard DRAM.

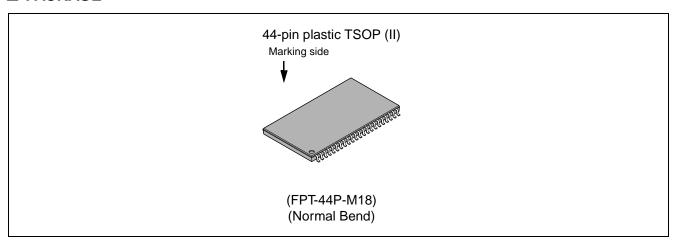
The MB81F16822B is ideally suited for laser printers, high resolution graphic adapters, accelerators and other applications where an extremely large memory and bandwidth are required and where a simple interface is needed.

■ PRODUCT LINE & FEATURES

| Parameter | MB81F16822B-75 | MB81F16822B-102 | MB81F16822B-103 | |
|--------------------------------------|--------------------|--------------------|--------------------|--|
| CL - trcd- trp | 3 - 3 - 3 clk min. | 2 - 2 - 2 clk min. | 3 - 2 - 2 clk min. | |
| Clock Frequency | 133 MHz max. | 100 MHz max. | 100 MHz max. | |
| Burst Mode Cycle Time | 7.5 ns min. | 10 ns min. | 10 ns min. | |
| Access Time From Clock | 6 ns max. (CL = 3) | 6 ns max. (CL = 2) | 6 ns max. (CL = 3) | |
| Operating Current (Two Banks Active) | 150 mA max. | 140 mA max. | 130 mA max. | |
| Power Down Mode Current (Icc2P) | 400μA max. | 400μA max. | 400μA max. | |
| Self Refresh Mode Current (Icc6) | 400μA max. | 400μA max. | 400μA max. | |

- Single +3.3 V Supply ±0.3 V tolerance
- LVTTL compatible I/O interface
- 4 K refresh cycles every 64 ms
- · Dual banks operation
- Burst read/write operation and burst read/single write operation capability
- Programmable burst type, burst length, and CAS latency
- Auto-and Self-refresh (every 15.6 μs)
- CKE power down mode
- Output Enable and Input Data Mask
- Asynchronous CKE self-refresh feature for low power (Icc6A = 400µA max.)

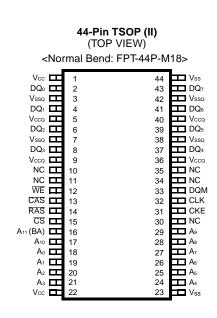
■ PACKAGE



Package and Ordering Information

- 44-pin plastic (400 mil) TSOP-II with normal bend leads,order as MB81F16822B-xxxFN

■ PIN ASSIGNMENTS AND DESCRIPTIONS

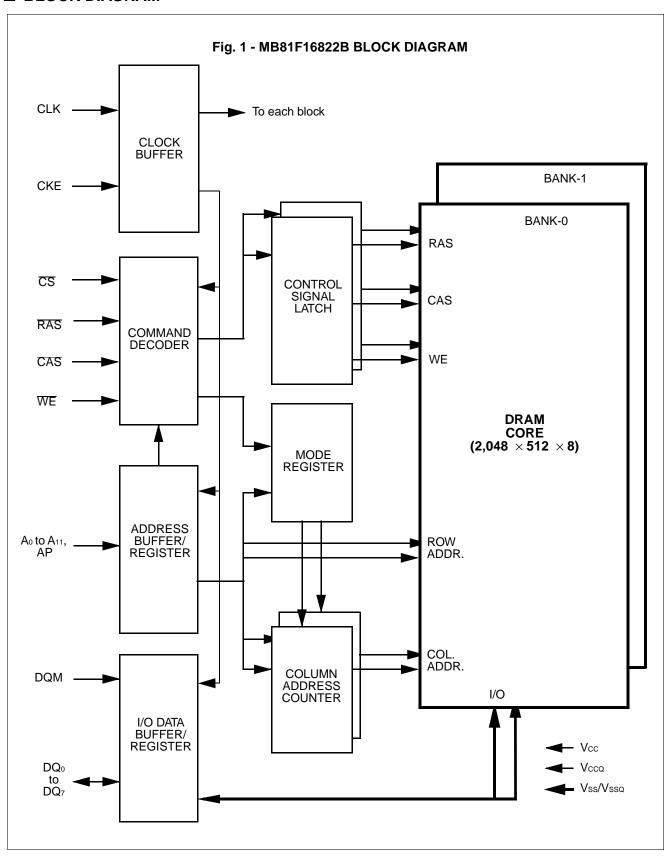


(Marking side)

| Pin Number | Symbol | Description |
|--|------------------------------------|---|
| 1, 5, 9, 22, 36, 40 | Vcc, Vccq | Supply Voltage |
| 2, 4, 6, 8, 37, 39, 41, 43 | DQ ₀ to DQ ₇ | Data I/O |
| 3, 7, 23, 38, 42, 44 | Vss, Vssq* | Ground |
| 12 | WE | Write Enable |
| 13 | CAS | Column Address Strobe |
| 14 | RAS | Row Address Strobe |
| 15 | CS | Chip Select |
| 16 | A ₁₁ (BA) | Bank Select |
| 17, 18, 19, 20, 21, 24, 25, 26, 27, 28, 29 | Ao to A ₁₀ | Address Input Row : Ao to A10 Column : Ao to A8 |
| 10, 11, 30, 34, 35 | NC | Non Connection |
| 31 | CKE | Clock Enable |
| 32 | CLK | Clock Input |
| 33 | DQM | Input Mask/Output Enable |

^{*:} These pins are connected internally in the chip.

■ BLOCK DIAGRAM



■ FUNCTIONAL TRUTH TABLE (Note 1)

COMMAND TRUTH TABLE Notes 2,3,4

| Function | Notes | Symbol | CI | KE | CS | RAS | CAS | WE | A 11 | A 10 | A9 | A ₈ to |
|---------------------------|-------|--------|-----|-----------|----|-----|-----|-----|-------------|-------------|----|-------------------|
| i diletion | NOIGS | Symbol | n-1 | n | 03 | NAS | CAS | VVL | (BA) | (AP) | A9 | Ao |
| Device Deselect | *5 | DESL | Н | Х | Н | Х | Х | Χ | Х | Х | Χ | Χ |
| No Operation | *5 | NOP | Н | Х | L | Н | Н | Н | Х | Х | Χ | Х |
| Burst Stop | | BST | Н | Х | L | Н | Н | L | Х | Х | Χ | Х |
| Read | *6 | READ | Н | Х | L | Н | L | Н | V | L | Χ | V |
| Read with Auto-precharge | *6 | READA | Н | Х | L | Н | L | Н | V | Н | Χ | V |
| Write | *6 | WRIT | Н | Х | L | Н | L | L | V | L | Χ | V |
| Write with Auto-precharge | *6 | WRITA | Н | Х | L | Н | L | L | V | Н | Χ | V |
| Bank Active (RAS) | *7 | ACTV | Н | Χ | L | L | Н | Η | V | V | V | V |
| Precharge Single Bank | | PRE | Н | Х | L | L | Н | L | V | L | Χ | Х |
| Precharge All Banks | | PALL | Н | Х | L | L | Н | L | Х | Н | Χ | Х |
| Mode Register Set | *8,9 | MRS | Η | Х | L | L | L | L | L | L | V | V |

Notes: *1. V = Valid, L = Logic Low, H = Logic High, X = either L or H.

- *2. All commands assume no CSUS command on previous rising edge of clock.
- *3. All commands are assumed to be valid state transitions.
- *4. All inputs are latched on the rising edge of clock.
- *5. NOP and DESL commands have the same effect on the part.
- *6. READ, READA, WRIT, and WRITA commands should only be issued after the corresponding bank has been activated (ACTV command). Refer to STATE DIAGRAM.
- *7. ACTV command should only be asserted after corresponding bank has been precharged (PRE or PALL command).
- *8. Required after power up.
- *9. MRS command should only be issued after all banks have been precharged (PRE or PALL command). Refer to STATE DIAGRAM.

DQM TRUTH TABLE

| Function | Command | CI | DQM | |
|--------------------------|---------|-----|-----|-------|
| Function | Command | n-1 | n | DQIVI |
| Data Write/Output Enable | ENBL | Н | Х | L |
| Data Mask/Output Disable | MASK | Н | Х | Н |

CKE TRUTH TABLE

| Current | Function N | otes | Symbol | Cł | KE | cs | RAS | CAS | WE | A 11 | A 10 | A 9 | |
|-----------------------|--------------------------|-------|--------|-----|-----------|----|-----|-----|------|-------------|-------------|-------------------|--|
| State | Function N | oles | Symbol | n-1 | n | CS | KAS | CAS | VV E | (BA) | (AP) | to A ₀ | |
| Bank Active | Clock Suspend Mode Entry | *1,*5 | CSUS | Н | L | Х | Х | Х | Х | Х | Х | Χ | |
| Any Except to Idle | Clock Suspend Continue | *1 | | L | L | Х | Х | Х | Х | Х | Х | Х | |
| Clock Suspend | Clock Suspend Mode Exit | | | L | Н | Х | Х | Х | Χ | Х | Х | Х | |
| Idle | Auto-refresh Command | *2,*4 | REF | Н | Н | L | L | L | Н | Х | Х | Χ | |
| Idle | Self-refresh Entry | *2,*3 | SELF | Н | L | L | L | L | Н | Х | Х | Χ | |
| Self- | Self-refresh Exit | | SELFX | L | Н | L | Н | Н | Н | Х | Х | Χ | |
| refresh | Sell-Tellesit Exit | | SELFA | L | Н | Н | Х | Х | Х | Х | Х | Χ | |
| Idlo | Dower Down Entry | *3 | PD | Н | L | L | Н | Н | Н | Χ | Х | Χ | |
| Idle | Power Down Entry | 3 | Рυ | Н | L | Н | Х | Х | Х | Х | Х | Χ | |
| Dower Down | Dower Down Evit | | | L | Н | L | Н | Н | Н | Х | Х | Χ | |
| Power Down | Power Down Exit | | | L | Н | Н | Х | Х | Х | Х | Х | Х | |

Notes: *1. The CSUS command requires that at least one bank is active. Refer to STATE DIAGRAM.

- *2. REF and SELF commands should only be issued after all banks have been precharged (PRE or PAL command). Refer to STATE DIAGRAM.
- *3. Self and PD commands should only be issued after the last data have been appeared on DQ.
- *4. Once it enters the auto-refresh mode, Asynchronous Self-refresh Entry exceuted when CKE is brought Low together with DSEL or NOP command(ASE command) within tase.
- *5. NOP or DSEL commands should only be issued after CSUS and PRE(or PALL) commands asserted at same time.

OPERATION COMMAND TABLE (Applicable to single bank)

| Current State | cs | RAS | CAS | WE | Addr | Command | Function Notes |
|------------------|----|-----|-----|----|------------|------------|---|
| Idle | Н | Х | Х | Х | Х | DESL | NOP |
| | L | Н | Н | Н | Х | NOP | NOP |
| | L | Н | Н | L | Х | BST | NOP |
| | L | Н | L | Н | BA, CA, AP | READ/READA | Illegal *2 |
| | L | Н | L | L | BA, CA, AP | WRIT/WRITA | Illegal *2 |
| | L | L | Н | Н | BA, RA | ACTV | Bank Active after tRCD |
| | L | L | Н | L | BA, AP | PRE/PALL | NOP *6 |
| | L | L | L | Н | Х | REF/SELF | Auto-refresh or Self-refresh *3 |
| | L | L | L | L | MODE | MRS | Mode Register Set (Idle after trsc) *3,*7 |
| Bank Active | Н | Х | Х | Х | Х | DESL | NOP |
| | L | Н | Н | Н | Х | NOP | NOP |
| | L | Н | Н | L | Х | BST | NOP |
| | L | Н | L | Н | BA, CA, AP | READ/READA | Begin Read; Determine AP |
| | L | Н | L | L | BA, CA, AP | WRIT/WRITA | Begin Write; Determine AP |
| | L | L | Н | Н | BA, RA | ACTV | Illegal *2 |
| | L | L | Н | L | BA, AP | PRE/PALL | Precharge; Determine Precharge Type |
| | L | L | L | Н | Х | REF/SELF | Illegal |
| | L | L | L | L | MODE | MRS | Illegal |

| Current State | cs | RAS | CAS | WE | Addr | Command | Function Notes |
|------------------|----|-----|-----|----|------------|------------|--|
| Read | Н | Х | Х | Х | Х | DESL | NOP (Continue Burst to End → Bank Active) |
| | L | Н | Н | Н | Х | NOP | NOP (Continue Burst to End → Bank Active) |
| | L | Н | Н | L | Х | BST | Burst Stop → Bank Active |
| | L | Н | L | Н | BA, CA, AP | READ/READA | Terminate Burst, New Read; Determine AP |
| | L | Н | L | L | BA, CA, AP | WRIT/WRITA | Terminate Burst, Start Write; Determine AP |
| | L | L | Н | Н | BA, RA | ACTV | Illegal *2 |
| | L | L | Н | L | BA, AP | PRE/PALL | Terminate Burst, Precharge; → Idle Determine Precharge Type |
| | L | L | L | Н | Х | REF/SELF | Illegal |
| | L | L | L | L | MODE | MRS | Illegal |
| Write | Н | Х | Х | Х | Х | DESL | NOP (Continue Burst to End → Bank Active) |
| | L | Н | Н | Н | Х | NOP | NOP (Continue Burst to End → Bank Active) |
| | L | Н | Н | L | Х | BST | Burst Stop → Bank Active |
| | L | Н | L | Н | BA, CA, AP | READ/READA | Terminate Burst, Start Read; Determine AP |
| | L | Н | L | L | BA, CA, AP | WRIT/WRITA | Terminate Burst, New Write; Determine AP |
| | L | L | Н | Н | BA, RA | ACTV | Illegal *2 |
| | L | L | Н | L | BA, AP | PRE/PALL | Terminate Burst, Precharge; Determine Precharge Type |
| | L | L | L | Н | Х | REF/SELF | Illegal |
| | L | L | L | L | MODE | MRS | Illegal |

| Current State | cs | RAS | CAS | WE | Addr | Command | Function | Notes |
|----------------------------------|----|-----|-----|----|------------|------------|--|-------|
| Read with Auto- precharge | Н | Х | Х | Х | Х | DESL | NOP (Continue Burst to End \rightarrow Precharge \rightarrow Idle) | |
| precharge | L | Н | Н | Н | Х | NOP | NOP (Continue Burst to End \rightarrow Precharge \rightarrow Idle) | |
| | L | Н | Н | L | Х | BST | Illegal | |
| | L | Н | L | Н | BA, CA, AP | READ/READA | Illegal | *2 |
| | L | Н | L | L | BA, CA, AP | WRIT/WRITA | Illegal | *2 |
| | L | L | Н | Н | BA, RA | ACTV | Illegal | *2 |
| | L | L | Н | L | BA, AP | PRE/PALL | Illegal | *2 |
| | L | L | L | Н | Х | REF/SELF | Illegal | |
| | L | L | L | L | MODE | MRS | Illegal | |
| Write with Auto- precharge | Н | Х | Х | Х | Х | DESL | NOP (Continue Burst to End \rightarrow Precharge \rightarrow Idle) | |
| precharge | L | Н | Н | Н | Х | NOP | NOP (Continue Burst to End \rightarrow Precharge \rightarrow Idle) | |
| | L | Н | Н | L | Х | BST | Illegal | |
| | L | Н | L | Н | BA, CA, AP | READ/READA | Illegal | *2 |
| | L | Н | L | L | BA, CA, AP | WRIT/WRITA | Illegal | *2 |
| | L | L | Н | Н | BA, RA | ACTV | Illegal | *2 |
| | L | L | Н | L | BA, AP | PRE/PALL | Illegal | *2 |
| | L | L | L | Н | Х | REF/SELF | Illegal | |
| | L | L | L | L | MODE | MRS | Illegal | |

| Current State | cs | RAS | CAS | WE | Addr | Command | Function | Notes |
|------------------|----|-----|-----|----|------------|------------|----------------------------------|-------|
| Precharge | Н | Х | Х | Х | Х | DESL | NOP (Idle after trp) | |
| | L | Н | Н | Н | Х | NOP | NOP (Idle after trp) | |
| | L | Н | Н | L | Х | BST | Illegal | |
| | L | Н | L | Н | BA, CA, AP | READ/READA | Illegal | *2 |
| | L | Н | L | L | BA, CA, AP | WRIT/WRITA | Illegal | *2 |
| | L | L | Н | Н | BA, RA | ACTV | Illegal | *2 |
| | L | L | Н | L | BA, AP | PRE/PALL | NOP (PALL may effect other bank) | *5 |
| | L | L | L | Н | Х | REF/SELF | Illegal | |
| | L | L | L | L | MODE | MRS | Illegal | |
| Bank | Н | Х | Х | Х | Х | DESL | NOP (Bank Active after tRCD) | |
| Activating | L | Н | Н | Н | Х | NOP | NOP (Bank Active after tRCD) | |
| | L | Н | Н | L | Х | BST | NOP (Bank Active after tRCD) | |
| | L | Н | L | Н | BA, CA, AP | READ/READA | Illegal | *2 |
| | L | Н | L | L | BA, CA, AP | WRIT/WRITA | Illegal | *2 |
| | L | L | Н | Н | BA, RA | ACTV | Illegal | *2 |
| | L | L | Н | L | BA, AP | PRE/PALL | Illegal | *2 |
| | L | L | L | Н | Х | REF/SELF | Illegal | |
| | L | L | L | L | MODE | MRS | Illegal | |

(Continued)

| Current State | cs | RAS | CAS | WE | Addr | Command | Function Notes |
|------------------|----|-----|-----|----|------|------------------------------------|--------------------------------------|
| Refreshing | Н | Х | Х | Х | Х | DESL | NOP (Idle after t _{RC}) *8 |
| | L | Н | Н | Х | Х | NOP/BST | NOP (Idle after t _{RC}) *8 |
| | L | Н | L | Х | Х | READ/READA/ WRIT/WRITA | Illegal |
| | L | L | Н | Х | Х | ACTV/PRE/ PALL | Illegal |
| | L | L | L | Х | Х | REF/SELF/ MRS | Illegal |
| Mode Register | Н | Х | Х | Х | Х | DESL | NOP (Idle after trsc) |
| Setting | L | Н | Н | Н | Х | NOP | NOP (Idle after trsc) |
| | L | Н | Н | L | Х | BST | Illegal |
| | L | Н | L | Х | Х | READ/READA/ WRIT/WRITA | Illegal |
| | L | L | Х | Х | Х | ACTV/PRE/ PALL/REF/ SELF/MRS | Illegal |

ABBREVIATIONS:

RA = Row Address BA = Bank Address CA = Column Address AP = Auto Precharge

COMMAND TRUTH TABLE FOR CKE

| Current State | CKE n-1 | CKE n | cs | RAS | CAS | WE | Addr | Function Notes |
|------------------|------------|----------|----|-----|-----|----|------|---|
| Self- refresh | Н | Х | Х | Х | Х | Х | Х | Invalid |
| renesii | L | Н | Н | Х | Х | Х | Х | Exit Self-refresh (Self-refresh Recovery → Idle after t _{RC}) |
| | L | Н | L | Н | Н | Н | Х | Exit Self-refresh (Self-refresh Recovery → Idle after tRc) |
| | L | Н | L | Н | Н | L | | Illegal |
| | L | Н | L | Н | L | Х | Х | Illegal |
| | L | Н | L | L | Х | Х | Х | Illegal |
| | L | L | Х | Х | Х | Х | Х | NOP (Maintain Self-refresh) |
| Self- refresh | L | Х | Х | Х | Х | Х | Х | Invalid |
| Recovery | Н | Н | Н | Х | Х | Х | Х | Idle after trc |
| | Н | Н | L | Н | Н | Н | Х | Idle after trc |
| | Н | Н | L | Н | Н | L | Х | Illegal |
| | Н | Н | L | Н | L | Х | Х | Illegal |
| | Н | Н | L | L | Х | Х | Х | Illegal |
| | Н | Н | Х | Х | Х | Х | Х | Illegal |
| | Н | L | Х | Х | Х | Х | Х | Illegal |

| Current State | CKE n-1 | CKE n | cs | RAS | CAS | WE | Addr | Function Notes |
|------------------|------------|----------|----|-----|-----|----|------|---------------------------------------|
| Power Down | Н | Х | Х | Х | Х | Х | | Invalid |
| Down | L | Н | Н | Х | Х | Х | Х | Exit Power Down Mode → Idle |
| | L | Н | L | Н | Н | Н | Х | Exit Power Down Mode → Idle |
| | L | L | Х | Х | Х | Х | Х | NOP (Maintain Power Down Mode) |
| | L | Н | L | L | Х | Х | Х | Illegal |
| | L | Н | L | Н | L | Х | Х | Illegal |
| Both Banks | Н | Н | Н | Х | Х | Х | | Refer to the Operation Command Table. |
| Idle | Н | Н | L | Н | Х | Х | | Refer to the Operation Command Table. |
| | Н | Н | L | L | Н | Х | | Refer to the Operation Command Table. |
| | Н | Н | L | L | L | Н | Х | Auto-refresh |
| | Н | Н | L | L | L | L | MODE | Refer to the Operation Command Table. |
| | Н | L | Н | Х | Х | Х | Х | Power Down |
| | Н | L | L | Н | Н | Н | Х | Power Down |
| | Н | L | L | Н | Н | L | Х | Illegal |
| | Н | L | L | Н | L | Х | | Illegal |
| | Н | L | L | L | Н | Х | | Illegal |
| | Н | L | L | L | L | Н | Х | Self-refresh |
| | Н | L | L | L | L | L | MODE | Illegal |
| | L | Х | Х | Х | Х | Х | Х | Invalid |

(Continued)

| Current State | CKE n-1 | CKE n | cs | RAS | CAS | WE | Addr | Function Notes |
|--------------------------|------------|----------|----|-----|-----|----|------|--------------------------------------|
| Bank Active Bank | Н | Н | Х | Х | Х | Х | Х | Refer to the Operation Command Table |
| Activating Read/Write | Н | L | Х | Х | Х | Х | Х | Begin Clock Suspend Next Cycle |
| | L | Х | Х | Х | Х | Х | Х | Invalid |
| Clock Suspend | Н | Х | Х | Х | Х | Х | Х | Invalid |
| Оизрени | L | Н | Х | Х | Х | Х | Х | Exit Clock Suspend Next Cycle |
| | L | L | Х | Х | Х | Х | Х | Maintain Clock Suspend |
| Any State Other Than | Н | Н | Х | Х | Х | Х | Х | Refer to the Operation Command Table |
| Listed Above | Н | L | Х | Х | Х | Х | Х | Illegal |
| | L | Х | Х | Х | Х | Х | Х | Invalid |

Notes: *1. All entries assume the CKE was High during the proceeding clock cycle and the current clock cycle. Illegal means don't used command. If used, power up sequence be asserted after power shut down.

- *2. Illegal to bank in specified state; entry may be legal in the bank specified by BA, depending on the state of that bank.
- *3. Illegal if any bank is not idle.
- *4. Must satisfy bus contention, bus turn around, and/or write recovery requirements.
- *5. NOP to bank precharging or in idle state. May precharge bank specified by BA (and AP).
- *6. SELF command should only be issued after the last read data have been appeared on DQ.
- *7. MRS command should only be issued on condition that all DQ are in Hi-Z.
- *8. Asynchronous Self-refresh Entry executed when CKE is brought Low together with DSEL or NOP command(ASE command) within tase.

■ FUNCTIONAL DESCRIPTION

SDRAM BASIC FUNCTION

Three major differences between this SDRAM and conventional DRAMs are: synchronized operation, burst mode, and mode register.

The **synchronized operation** is the fundamental difference. An SDRAM uses a clock input for the synchronization, where the DRAM is basically asynchronous memory although it has been using two clocks, RAS and CAS. Each operation of DRAM is determined by their timing phase differences while each operation of SDRAM is determined by commands and all operations are referenced to a positive clock edge. Fig.2 shows the basic timing diagram differences between SDRAMs and DRAMs.

The **burst mode** is a very high speed access mode utilizing an internal column address generator. Once a column addresses for the first access is set, following addresses are automatically generated by the internal column address counter.

The **mode register** is to justify the SDRAM operation and function into desired system conditions. MODE REGISTER TABLE shows how SDRAM can be configured for system requirement by mode register programming.

CLOCK (CLK) AND CLOCK ENABLE (CKE)

All input and output signals of SDRAM use register type buffers. A CLK is used as a trigger for the register and internal burst counter increment. All inputs are latched by a positive edge of CLK. All outputs are validated by the CLK. CKE is a high active clock enable signal. When CKE = Low is latched at a clock input during active cycle, the next clock will be internally masked. During idle state (all banks have been precharged), the Power Down mode(standby) is entered with CKE = Low and this will make extremely low standby current.

CHIP SELECT (CS)

CS enables all commands inputs, RAS, CAS, and WE, and address input. When CS is High, command signals are negated but internal operation such as burst cycle will not be suspended. If such a control isn't needed, CS can be tied to ground level.

COMMAND INPUTS (RAS, CAS AND WE)

Unlike a conventional DRAM, RAS, CAS, and WE do not directly imply SDRAM operation, such as Row address strobe by RAS. Instead, each combination of RAS, CAS, and WE input in conjunction with CS input at a rising edge of the CLK determines SDRAM operation. Refer to FUNCTIONAL TRUTH TABLE in page 5.

ADDRESS INPUTS (Ao to A10)

Address input selects an arbitrary location of a total of 1,048,576 words of each memory cell matrix. A total of twenty address input signals are required to decode such a matrix. SDRAM adopts an address multiplexer in order to reduce the pin count of the address line. At a Bank Active command (ACTV), eleven Row addresses are initially latched and the remainder of nine Column addresses are then latched by a Column address strobe command of either a Read command (READ or READA) or Write command (WRIT or WRITA).

BANK SELECT (A11)

This SDRAM has two banks and each bank is organized as 1 M words by 8-bit. Bank selection by A₁₁ occurs at Bank Active command (ACTV) followed by read (READ or READA), write (WRIT or WRITA), and precharge command (PRE).

DATA INPUTS AND OUTPUTS (DQ₀ to DQ₇)

Input data is latched and written into the memory at the clock following the write command input. Data output is obtained by the following conditions followed by a read command input:

trac: from the bank active command when tred (min) is satisfied. (This parameter is reference only.)

tcac: from the read command when tRCD is greater than tRCD (min). (This parameter is reference only.)

tac: from the clock edge after trac and toac.

The polarity of the output data is identical to that of the input. Data is valid between access time (determined by the three conditions above) and the next positive clock edge (toh).

DATA I/O MASK (DQM)

DQM is active high enable inputs and have an output disable and input mask function. During burst cycle and when DQM = High is latched by a clock, input is masked at the same clock and output will be masked at the second clock later while internal burst counter will increment by one or will go to the next stage depending on burst type.

BURST MODE OPERATION AND BURST TYPE

The burst mode provides faster memory access. The burst mode is implemented by keeping the same Row address and by automatic strobing column address. Access time and cycle time of Burst mode is specified as tac and tok, respectively. The internal column address counter operation is determined by a mode register which defines burst type and burst count length of 1,2,4 or 8 bits of boundary. In order to terminate or to move from the current burst mode to the next stage while the remaining burst count is more than 1, the following combinations will be required:

| Current Stage | Next Stage | N | Method (Assert the following command) | | | | | |
|---------------|-------------|-------------------|--|--|--|--|--|--|
| Burst Read | Burst Read | Read Comma | Read Command | | | | | |
| Burst Read | Burst Write | 1st Step | Mask Command (Normally 3 clock cycles) | | | | | |
| | buist write | 2nd Step | Write Command after lowd | | | | | |
| Burst Write | Burst Write | Write Command | | | | | | |
| Burst Write | Burst Read | Read Comma | nd | | | | | |
| Burst Read | Precharge | Precharge Command | | | | | | |
| Burst Write | Precharge | Precharge Co | Precharge Command | | | | | |

The burst type can be selected either sequential or interleave mode if burst length is 2,4 or 8. The sequential mode is an incremental decoding scheme within a boundary address to be determined by count length, it assigns +1 to the previous (or initial) address until reaching the end of boundary address and then wraps round to least significant address(=0). The interleave mode is a scrambled decoding scheme for A₀ and A₂. If the first access of column address is even (0), the next address will be odd (1), or vice-versa.

(Continued)

When the full burst operation is executed at single write mode, Auto-precharge command is valid only at write operation.

The burst type can be selected either sequential or interleave mode. But only the sequential mode is usable to the full column burst. The sequential mode is an incremental decoding scheme within a boundary address to be determined by burst length, it assigns +1 to the previous (or initial) address until reaching the end of boundary address and then wraps round to least significant address(=0).

| Burst Length | Stating Column Address A ₂ A ₁ A ₀ | Sequential Mode | Interleave |
|-----------------|---|-------------------------------|-------------------------------|
| 2 | X X 0 | 0 - 1 | 0 - 1 |
| 2 | X X 1 | 1 - 0 | 1 - 0 |
| | X 0 0 | 0 - 1 - 2 - 3 | 0 - 1 - 2 - 3 |
| 1 | X 0 1 | 1 - 2 - 3 - 0 | 1 - 0 - 3 - 2 |
| 4 | X 1 0 | 2 - 3 - 0 - 1 | 2 - 3 - 0 - 1 |
| | X 1 1 | 3 - 0 - 1 - 2 | 3 - 2 - 1 - 0 |
| | 0 0 0 | 0 - 1 - 2 - 3 - 4 - 5 - 6 - 7 | 0 - 1 - 2 - 3 - 4 - 5 - 6 - 7 |
| | 0 0 1 | 1 - 2 - 3 - 4 - 5 - 6 - 7 - 0 | 1 - 0 - 3 - 2 - 5 - 4 - 7 - 6 |
| | 0 1 0 | 2 - 3 - 4 - 5 - 6 - 7 - 0 - 1 | 2 - 3 - 0 - 1 - 6 - 7 - 4 - 5 |
| 8 | 0 1 1 | 3 - 4 - 5 - 6 - 7 - 0 - 1 - 2 | 3 - 2 - 1 - 0 - 7 - 6 - 5 - 4 |
| 0 | 1 0 0 | 4 - 5 - 6 - 7 - 0 - 1 - 2 - 3 | 4 - 5 - 6 - 7 - 0 - 1 - 2 - 3 |
| | 1 0 1 | 5 - 6 - 7 - 0 - 1 - 2 - 3 - 4 | 5 - 4 - 7 - 6 - 1 - 0 - 3 - 2 |
| | 1 1 0 | 6 - 7 - 0 - 1 - 2 - 3 - 4 - 5 | 6 - 7 - 4 - 5 - 2 - 3 - 0 - 1 |
| | 1 1 1 | 7 - 0 - 1 - 2 - 3 - 4 - 5 - 6 | 7 - 6 - 5 - 4 - 3 - 2 - 1 - 0 |

FULL COLUMN BURST AND BURST STOP COMMAND (BST)

The full column burst is an option of burst length and available only at sequential mode of burst type. This full column burst mode is repeatedly access to the same column. If burst mode reaches end of column address, then it wraps round to first column address (=0) and continues to count until interrupted by the news Read (READ) /Write (WRIT) , Precharge (PRE) , or Burst Stop (BST) command. The selection of Auto-precharge option is illegal during the full column burst operation except write command at BURST READ & SINGLE WRITE mode.

The BST command is applicable to terminated burst operation. If the BST command is asserted burst mode, its operation is terminated immediately and the internal state moves to Bank Active.

When read mode is interrupted by BST command, the output will be in High-Z.

For the detail rule, please refer to TIMING DIAGRAM-8.

When write mode is interrupted by BST command, the data to be applied at the same time with BST command will be ignored.

BURST READ & SINGLE WRITE

The burst read and single write mode provides single word write operation regardless of its burst length. In this mode, burst read operation does not affected by this mode.

PRECHARGE AND PRECHARGE OPTION (PRE, PALL)

SDRAM memory core is the same as conventional DRAMs', requiring precharge and refresh operations. Precharge rewrites the bit line and to reset the internal Row address line and is executed by the Precharge command (PRE). With the Precharge command, SDRAM will automatically be in standby state after precharge time (trp).

The precharged bank is selected by combination of AP and A₁₁ when Precharge command is asserted. If AP = High, both banks are precharged regardless of A₁₁ (PALL). If AP = Low, a bank to be selected by A₁₁ is precharged (PRE). The Auto-precharge enters precharge mode at the end of burst mode of read or write without Precharge command assertion. This Auto-precharge is entered by AP = High when a read or write command is asserted. Refer to FUNCTION TRUTH TABLE.

AUTO-REFRESH (REF)

Auto-refresh uses the internal refresh address counter. The SDRAM Auto-refresh command (REF) generates Precharge command internally. All banks of SDRAM should be precharged prior to the Auto-refresh command. The Auto-refresh command should also be asserted every 15.6 μ s or a total 4096 refresh commands within a 64 ms period.

SELF-REFRESH ENTRY (SELF)

Self-refresh function provides automatic refresh by an internal timer as well as Auto-refresh and will continue the refresh function until cancelled by SELFX.

The Self-refresh is entered by applying an Auto-refresh command in conjunction with CKE = Low (SELF). Once SDRAM enters the self-refresh mode, all inputs except for CKE will be "don't care" (either logic high or low level state) and outputs will be in a High-Z state. During a Self-refresh mode, CKE = Low should be maintained. SELF command should only be issued after last read data has been appeared on DQ.

ASYNCHRONOUS SELF-REFRESH ENTRY(ASE)

The SELF command requires high speed control to the CKE as well as other command inputs. The MB81F16822B supports Asynchronous Self-refresh entry and it executed when CKE is brought Low together with DSEL or NOP command(ASE command) within tase(min). Once it enters the self-refresh mode, CKE=Low should be maintained as the same manner as regular Self-refresh mode. ASE command should only be effective if not of access command is issued after the last REF command has been issued.

SELF-REFRESH EXIT (SELFX)

To Exit SElf-Refresh mode, apply minimum token before CKE brought high, and then the NOP command (NOP) or the Deselect command (DESL) should be asserted within minimum tRC. Refer to Timing Diagram for the detail. It is recommended to assert an Auto-refresh command just after the tro period to avoid the violation of refresh period.

MODE REGISTER SET (MRS)

The mode register of SDRAM provides a variety of different operations. The register consists of four operation fields; Burst Length, Burst Type, CAS latency, and Operation Code. Refer to MODE REGISTER TABLE in page 33.

The mode register can be programmed by the Mode Register Set command (MRS). Each field is set by the address line. Once a mode register is programmed, the contents of the register will be held until re-programmed by another MRS command (or part loses power). MRS command should only be issued on condition that all DQ is in Hi-Z.

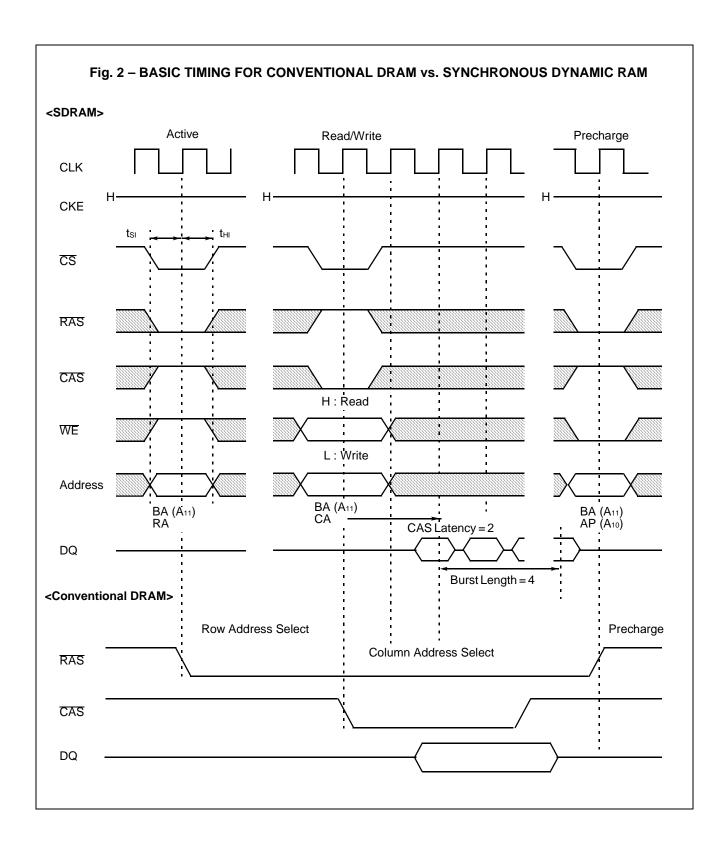
The condition of the mode register is undefined after the power-up stage. It is required to set each field after initialization of SDRAM. Refer to POWER-UP INITIALIZATION below.

POWER-UP INITIALIZATION

The SDRAM internal condition after power-up will be undefined. It is required to follow the following Power On Sequence to execute read or write operation.

- 1. Apply power and start clock. Attempt to maintain either NOP or DESL command at the input.
- 2. Maintain stable power, stable clock, and NOP condition for a minimum of 200 μ s.
- 3. Precharge all banks by Precharge (PRE) or Precharge All command (PALL).
- 4. Assert minimum of 8 Auto-refresh command(REF).
- 5. Program the mode register by Mode Register Set command(MRS).

In addition, it is recommended DQM and CKE to track Vcc to insure that output is High-Z state. The Mode Register Set command (MRS) can be set before 8 Auto-refresh command (REF).



MINIMUM CLOCK LATENCY OR DELAY TIME FOR 1 BANK OPERATION

| Second command (same bank) First command | MRS | ACTV | READ | READA | WRT | WRITA | PRE | PALL | REF | SELF |
|---|-------------------|-------------------------------|-------------|--------------------|---------|--------------------|--------------|--------------|-------------------|-------------------|
| MRS | trsc | t rsc | | | | | t rsc | trsc | trsc | trsc |
| ACTV | | | trcd | *4 t RCD | trcd | *4 t RCD | t ras | tras | | |
| READ | | | 1 | 1 | *1 1 | *1 1 | 1 | 1 | | |
| READA | BL + | *2 BL + t _{RP} | | | | | | | BL + | BL + |
| WRIT | | | t wr | t wr | 1 | 1 | t dpl | t dpl | | |
| WRITA | t dal | t dal | | | | | | | t dal | t dal |
| PRE | *3 t RP | *3 t RP | | | | | t RP | t RP | *3 t RP | *3 t RP |
| PALL | *3 t RP | *3 t RP | | | | | t RP | t RP | *3 t RP | *3 t RP |
| REF | t RC | t RC | | | | | t RC | t RC | t RC | t RC |
| SELFX | trc | t RC | | | | | | | t RC | trc |

Notes: *1. Assume no I/O conflict.

- *2. If $t_{RP} \le t_{CK}$, minimum latency is a sum of BL + CL.
- *3. Assume Output is in High-Z state.
- *4. Assume tras is satisfied.

| Illegal Command |
|-----------------|
|-----------------|

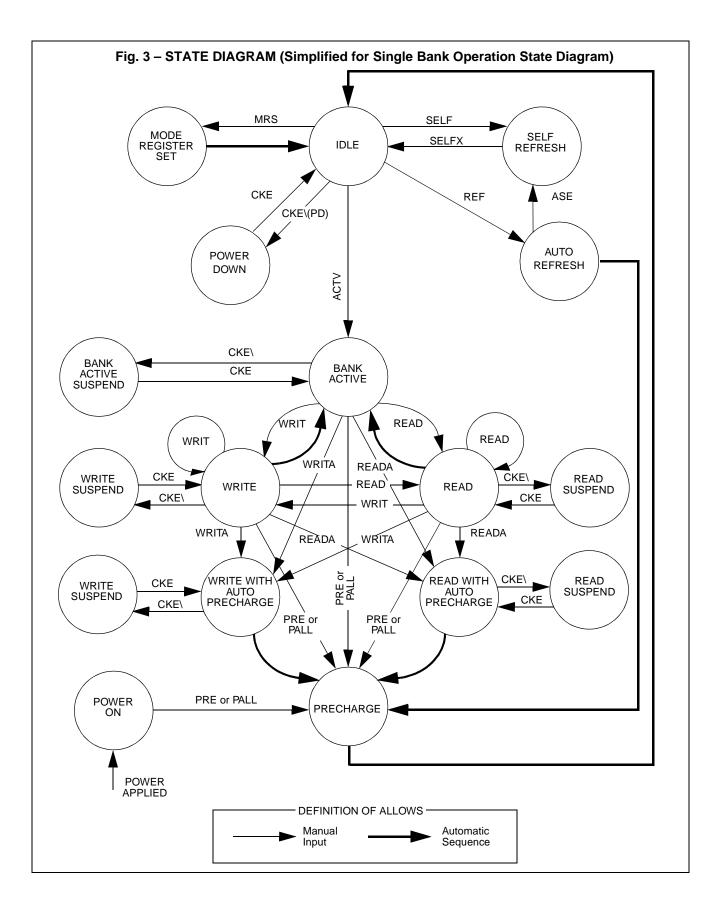
MINIMUM CLOCK LATENCY OR DELAY TIME FOR 2 BANK OPERATION

| Second command (opposite bank) First command | MRS | ACTV | READ | READA | WRT | WRITA | PRE | PALL | REF | SELF |
|---|-------------------------------------|--------------------|----------------|---------|----------------|----------|--------------|--------------|-------------------------------------|-----------------------------------|
| MRS | t rsc | t rsc | | | | | t rsc | trsc | trsc | t rsc |
| ACTV | | *1 t RRD | *2 1 | *2 1 | *2 1 | *2 1 | *7 1 | t ras | | |
| READ | | *1 1 | 1 | 1 | *2 *3 | *2 *3 | 1 | *8 1 | | |
| READA | *1 BL + t _{RP} | *1 1 | 1 | 1 | 1 | 1 | 1 | | *1 *4 BL + t _{RP} | *1 BL + t _{RP} |
| WRIT | | *1 1 | *2 1 | *2 1 | *2 1 | *2 1 | *7 1 | *8 1 | | |
| WRITA *9 | *1 *4 BL + t _{RP} | *1 1 | 1 | 1 | 1 | 1 | 1 | | *1 BL + 1 + t RP | *1 BL + 1 + t _{RP} |
| PRE | *1 t RP | *1 1 | *2 1 | *2 1 | *2 1 | *2 1 | 1 | t ras | *1 t RP | *1 t RP |
| PALL | t RP | *1 t RP | | | | | 1 | 1 | *1 *6 t RP | *1 *6 t RP |
| REF | t RC | t RC | | | | | t RC | t RC | t RC | t RC |
| SELFX | t RC | t RC | | | | | | | t rc | t RC |

Notes: *1. Assume opposite bank is in idle state.

- *2. Assume opposite bank is in active state.
- *3. Assume no I/O conflict.
- *4. If t_{RP} ≤ t_{CK}, minimum latency is a sum of BL + CL.
- *5. Assume PALL command dose not affect any operation on opposite bank.
- *6. Assume Output is in High-Z state.
- *7. Assume tras of opposite bank is satisfied.
- *8. Assume tras(ACTV to PALL) is satisfied.
- *9. If opposite bank should be interrupted, tRAS of own bank is satisfied...

22



■ ABSOLUTE MAXIMUM RATINGS (See WARNING)

| Parameter | Symbol | Value | Unit |
|---------------------------------------|--------------|--------------|------|
| Voltage of Vcc Supply Relative to Vss | Vcc | -0.5 to +4.6 | V |
| Voltage at Any Pin Relative to Vss | VIN, VOUT | -0.5 to +4.6 | V |
| Short Circuit Output Current | І оит | -50 to +50 | mA |
| Power Dissipation | Po | 1.3 | W |
| Storage Temperature | Тѕтс | -55 to +125 | °C |

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

(Referenced to Vss)

| Parameter | Notes | Symbol | Min. | Тур. | Max. | Unit |
|---------------------|-------|-----------|------|------|-----------|------|
| Supply Voltage | | Vcc, Vccq | 3.0 | 3.3 | 3.6 | V |
| Supply voltage | | Vss, Vssq | 0 | 0 | 0 | V |
| Input High Voltage | *1 | VIH | 2.0 | _ | Vcc + 0.5 | V |
| Input Low Voltage | *2 | VıL | -0.5 | _ | 0.8 | V |
| Ambient Temperature | | TA | 0 | _ | 70 | °C |

Notes: *1. Overshoot limit: V_H (max)= V_{CC} +1.5 V with a pulsewidth ≤ 5 ns.

*2. Undershoot limit: V_{IL} (min)= -1.5 V with a pulsewidth ≤ 5 ns

WARNING: Recommended operating conditions are normal operating ranges for the semiconductor device. All the device's electrical characteristics are warranted when operated within these ranges.

Always use semiconductor devices within the recommended operating conditions. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representative beforehand.

■ CAPACITANCE

 $(T_A = 25^{\circ}C, f = 1 \text{ MHz})$

| Parameter | Symbol | Min. | Тур. | Max. | Unit |
|-----------------------------------|------------------|------|------|------|------|
| Input Capacitance, Except for CLK | CIN1 | 2.5 | _ | 5 | pF |
| Input Capacitance for CLK | CIN2 | 2.5 | _ | 4 | pF |
| I/O Capacitance | C _{I/O} | 4.0 | _ | 6.5 | pF |

■ DC CHARACTERISTICS

(At recommended operating conditions unless otherwise noted.) Notes 1, 2

| Dara | ameter | Symbol | Conditions | Va | lue | Unit |
|---|-----------------|---------------------|---|------------|------|------|
| raid | ineter | | | Min. | Max. | |
| Output High Voltage | | V _{OH(DC)} | $I_{OH} = -2 \text{mA}$ | 2.4 | | V |
| Output Low Voltage | | Vol(DC) | IoL=2mA | _ | 0.4 | V |
| Input Leakage Curre | nt (Any Input) | lu | $0 \text{ V} \le \text{V}_{\text{IN}} \le \text{V}_{\text{CC}};$ All other pins not under test = 0 V | - 5 | 5 | μA |
| Output Leakage Cur | rent | Іьо | 0 V≤V _{IN} ≤V _{CC} ; Data out disabled | - 5 | 5 | μA |
| | MB81F16822B-75 | | Burst: Length=4, trc= min for BL=4, tck=min. | | 100 | |
| | MB81F16822B-102 | Icc1s | One bank active, Outputs open, Addresses changed up to | _ | 100 | mA |
| Operating Current (Average Power | MB81F16822B-103 | | 3-times during trc(min), 0 V ≤ V _{IN} ≤ V _{CC} | | 90 | |
| Supply Current) | MB81F16822B-75 | | Burst Length = 4 (each bank), trc = min for BL=4(each bank), tck=min. | | 150 | |
| | MB81F16822B-102 | Icc1D | All banks active, Output open, Addresses changed up to | _ | 140 | mA |
| | MB81F16822B-103 | | 3-times during t _{RC} (min), 0 V ≤ V _{IN} ≤ V _{CC} | | 130 | |
| Į. | | ICC2P | CKE=VIL, All banks idle, tcκ=min, Power down mode, 0 V≤VIN≤Vcc | _ | 400 | |
| | | Icc2PS | $CKE = V_{IL}$, All banks idle, CLK = HorL, Power down mode, $0 V \le V_{IN} \le V_{CC}$ | | 400 | μA |
| Precharge Standby Current (Power Supply | MB81F16822B-75 | | CKE = V _{IH} , All banks idle, tck = min, | _ | 27 | |
| Current) | MB81F16822B-102 | Icc2N | NOP commands only, Input signals (except to CMD) are changed one | _ | 20 | |
| | MB81F16822B-103 | | times during 3 clock cycles, $0 \text{ V} \le \text{V}_{\text{IN}} \le \text{V}_{\text{CC}}$ | _ | 20 | mA |
| | | Icc2NS | CKE=V _{IH} , All banks idle, CLK=HorL, Input signals are stable, 0 V≤V _{IN} ≤V _{CC} | _ | 15 | |

| Parameter | | Symbol | Conditions | Va | lue | Unit |
|--|-----------------|----------|---|------|------|------|
| | | Syllibol | | Min. | Max. | Onit |
| Active Standby Current (Power Supply Current) | | Іссзр | CKE=V _{IL} , Any bank active, tcκ=min, 0 V≤V _{IN} ≤V _{CC} | _ | 5 | mA |
| | | Іссзрѕ | CKE=V _{IL} , Any bank active, CLK=HorL, 0 V≤V _{IN} ≤V _{CC} | _ | 3 | mA |
| Active Standby | MB81F16822B-75 | | CKE = V _{IH} , Any bank active, tck = min, | _ | 54 | mA |
| Current (Power Supply Current) | MB81F16822B-102 | Іссзи | NOP commands only, Input signals (except to CMD) are changed one | _ | 40 | mA |
| Currenty | MB81F16822B-103 | | times during 3 clock cycles, 0 V ≤ V IN ≤ V cc | _ | 40 | mA |
| | | Іссзиѕ | CKE=V _{IH} , Any bank active, CLK=HorL, 0 V≤V _{IN} ≤V _{CC} | _ | 25 | mA |
| Burst mode | MB81F16822B-75 | | tck=min, Burst Length = 4, Outputs open, Multiple-banks active, | | 150 | mA |
| Current (Average Power Supply Current) | MB81F16822B-102 | Icc4 | | _ | 120 | |
| Зарріу Сипені) | MB81F16822B-103 | | Gapless data, 0 V≤V _{IN} ≤V _{CC} | | 120 | |
| D (10) | MB81F16822B-75 | | Auto-refresh; | | 100 | |
| Refresh Current #1 (Average Power | MB81F16822B-102 | Icc5 | tck=min, trc=min, | _ | 80 | mA |
| Supply Current) | MB81F16822B-103 | | 0 V≤VIN≤Vcc | | 80 | |
| Refresh Current #2 (Average Power Supply Current) | | Icc6 | Self-refresh; tcκ=min, CKE≤0.2 V, 0 V≤VIN≤Vcc | _ | 400 | μA |
| Refresh Current #2 (Average Power Supp | oly Current) | Icc6A | Asynchronous Self- refresh (by CLK stop); CKE \leq 0.2 V, CLK = V _{IL} , 0 V \leq V _{IN} \leq V _{CC} | _ | 400 | μA |

■ AC CHARACTERISTICS

(At recommended operating conditions unless otherwise noted.) Notes 2, 3, 4

| Parameter No | | Symbol | MB81F16822B -75 | | MB81F16822B -102 | | MB81F16822B -103 | | Unit |
|---|-----------------|------------------|--------------------|------|---------------------|------|---------------------|------|------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | |
| Clock Period | CAS Latency = 2 | t _{CK2} | 11.5 | _ | 10 | _ | 12 | _ | ns |
| | CAS Latency = 3 | t cкз | 7.5 | _ | 10 | _ | 10 | _ | ns |
| Clock High Time | tсн | 2.5 | _ | 3 | _ | 3 | _ | ns | |
| Clock Low Time | t cL | 2.5 | _ | 3 | _ | 3 | _ | ns | |
| Input Setup Time | t sı | 2 | _ | 2 | _ | 2 | _ | ns | |
| Input Hold Time | tнı | 1 | _ | 1 | _ | 1 | _ | ns | |
| Access Time from Clock (tck = min) *5,6 | CAS Latency = 2 | t _{AC2} | _ | 7 | _ | 6 | _ | 7 | ns |
| | CAS Latency = 3 | t AC3 | _ | 6 | _ | 6 | _ | 6 | ns |
| Output in Low-Z | | t LZ | 0 | _ | 0 | _ | 0 | _ | ns |
| Output in High-Z *7 | CAS Latency = 2 | t _{HZ2} | 3 | 7 | 3 | 6 | 3 | 7 | ns |
| | CAS Latency = 3 | t HZ3 | 2 | 6 | 3 | 6 | 3 | 6 | ns |
| Output Hold Time | CAS Latency = 2 | t o | 3 | _ | 3 | _ | 3 | _ | ns |
| | CAS Latency = 3 | t oн | 2 | _ | 3 | _ | 3 | _ | ns |
| Time between Auto-refresh command Interval | | t REFI | _ | 15.6 | _ | 15.6 | _ | 15.6 | μs |
| CKE Low(or CLK Low) Hold Time for Asynchronous Self-refresh Entry | | t ase | 100 | 200 | 100 | 200 | 100 | 200 | μs |
| Transition Time | tт | 0.5 | 2 | 0.5 | 2 | 0.5 | 2 | ns | |
| CKE Setup time for Power Down Exit | | tcksp | 3 | _ | 3 | _ | 3 | _ | ns |

BASE VALUES FOR CLOCK COUNT/LATENCY

| Parameter | Notes | Symbol | MB81F16822B -75 | | MB81F16822B -102 | | MB81F16822B -103 | | Unit |
|---|-----------------|---------------|----------------------|--------|----------------------|--------|----------------------|--------|------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | |
| RAS Cycle Time *8 | | trc | 67.5 | _ | 70 | _ | 70 | _ | ns |
| RAS Precharge Time | | t RP | 22.5 | _ | 20 | _ | 20 | _ | ns |
| RAS Active Time | | t ras | 45 | 110000 | 50 | 110000 | 50 | 110000 | ns |
| RAS to CAS Delay Time *9 | | t RCD | 22.5 | _ | 20 | _ | 20 | _ | ns |
| Write Recovery Time | | twR | 7.5 | _ | 10 | _ | 10 | _ | ns |
| Data-in to Precharge Lead Time | | t DPL | 7.5 | _ | 10 | _ | 10 | _ | ns |
| Data-in to Active/Refresh Command Period | CAS Latency = 2 | tDAL2 | 1cyc+t _{RP} | _ | 1cyc+t _{RP} | | 1cyc+t _{RP} | _ | ns |
| | CAS Latency = 3 | t DAL3 | 2cyc+t _{RP} | _ | 2cyc+t _{RP} | _ | 2cyc+t _{RP} | _ | ns |
| Mode Register Set Cycle Time | | trsc | 15 | _ | 20 | | 20 | _ | ns |
| RAS to RAS Bank Active Delay Time | | t rrd | 15 | _ | 20 | _ | 20 | _ | ns |

CLOCK COUNT FORMULA Note10

$$Clock \geq \frac{Base\ Value}{Clock\ Period} \quad (Round\ off\ a\ whole\ number)$$

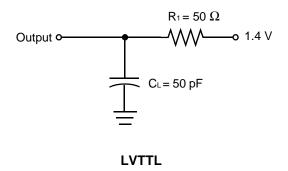
LATENCY-FIXED VALUES

(The latency values on these parameters are fixed regardless of clock period.)

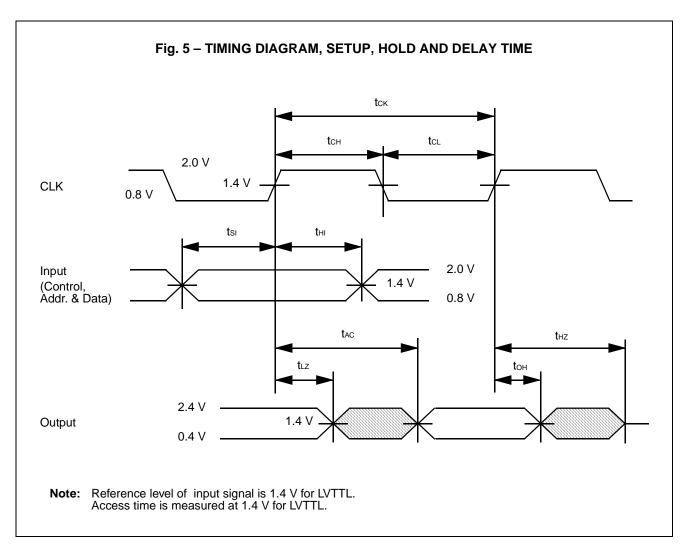
| Parameter | Notes | Symbol | MB81F16822B -75 | MB81F16822B -102 | MB81F16822B -103 | Unit |
|---|--------|-------------------|--------------------|---------------------|---------------------|-------|
| CKE to Clock Disable | | Іске | 1 | 1 | 1 | cycle |
| DQM to Output in High-Z | | ldqz | 2 | 2 | 2 | cycle |
| DQM to Input Data Delay | | IDQD | 0 | 0 | 0 | cycle |
| Last Output to Write Command Delay | | lowd | 2 | 2 | 2 | cycle |
| Write Command to Input Data Delay | | lowd | 0 | 0 | 0 | cycle |
| Precharge to Output in High-Z Delay | CL = 2 | Iroh2 | 2 | 2 | 2 | cycle |
| | CL = 3 | Ігонз | 3 | 3 | 3 | cycle |
| Burst Stop Command to Output in High-Z Delay | CL = 2 | I _{BSH2} | 2 | 2 | 2 | cycle |
| | CL = 3 | Івѕнз | 3 | 3 | 3 | cycle |
| CAS to CAS Delay (min) | 1 | Iccd | 1 | 1 | 1 | cycle |
| CAS Bank Delay (min) | | ICBD | 1 | 1 | 1 | cycle |

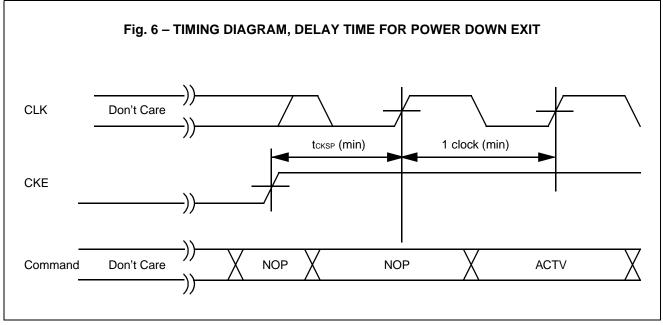
- **Notes:** *1. lcc depends on the output termination or load conditions, clock cycle rate, and signal clocking rate; the specified values are obtained with the output open and no termination register.
 - *2. An initial pause (DESL or NOP) of 200 μs is required after power-up followed by a minimum of eight Auto-refresh cycles.
 - *3. AC characteristics assume $t_T = 1$ ns and 50 pF of capacitive load.
 - *4. 1.4 V is the reference level for measuring timing of input signals. Transition times are measured between V_{IH} (min) and V_{IL} (max).
 - *5. Assumes tRCD is satisfied.
 - *6. tac also specifies the access time at burst mode.
 - *7. Specified where output buffer is no longer driven.
 - *8. Actual clock count of trc (Irc) will be sum of clock count of tras (Iras) and trp (Irp).
 - *9. Operation within the trcd (min) ensures that access time is determined by trcd(min) + tac(max); If trcd is greater than the specified trcd (min), access time is determined by trac.
 - *10. All base values are measured from the clock edge at the command input to the clock edge for the next command input. All clock counts are calculated by a simple formula:
 - clock count equals base value divided by clock period (round off to a whole number).

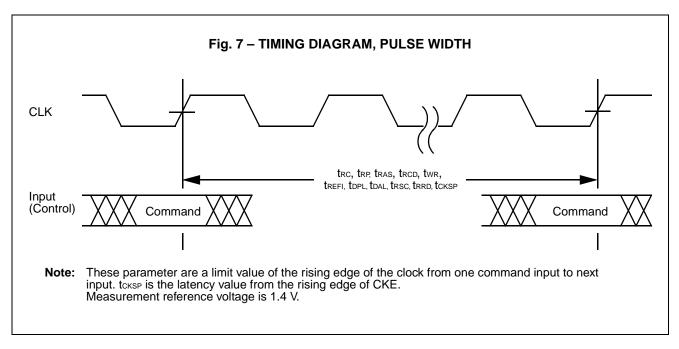
Fig. 4 – EXAMPLE OF AC TEST LOAD CIRCUIT

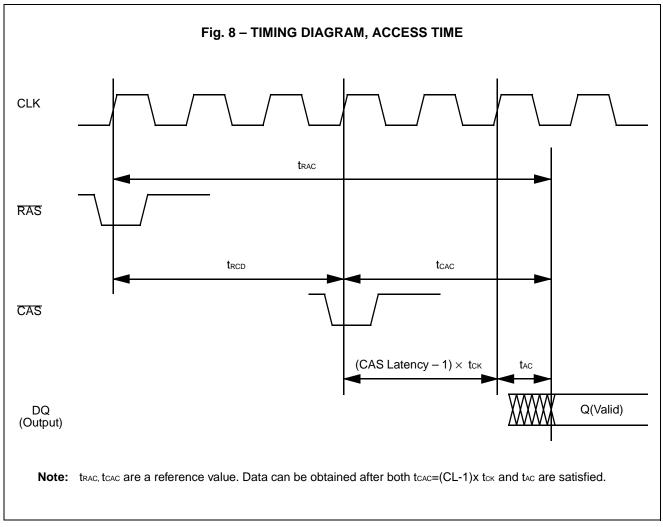


Note: AC characteristics are measured in this condition. This load circuits are not applicable for Voh and Vol.

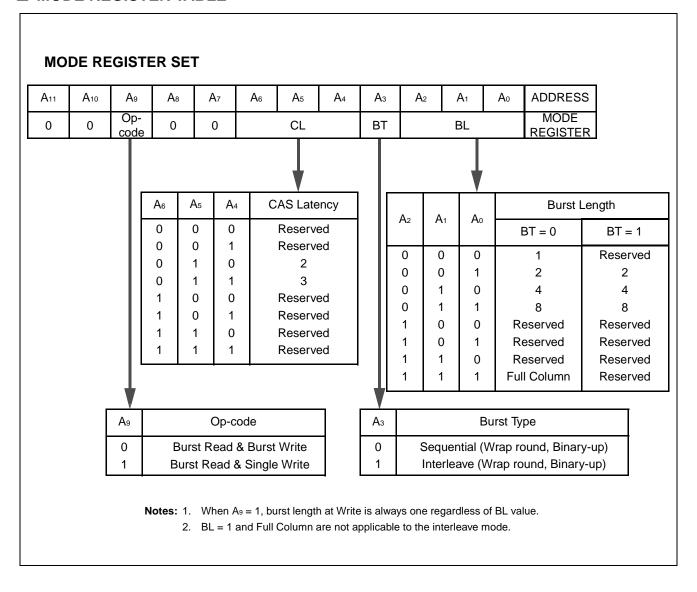


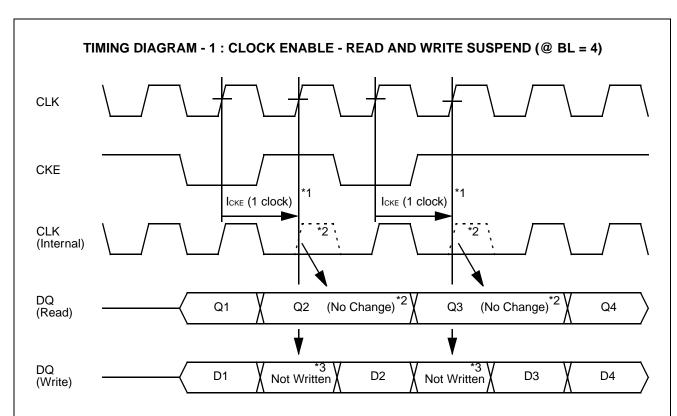






■ MODE REGISTER TABLE

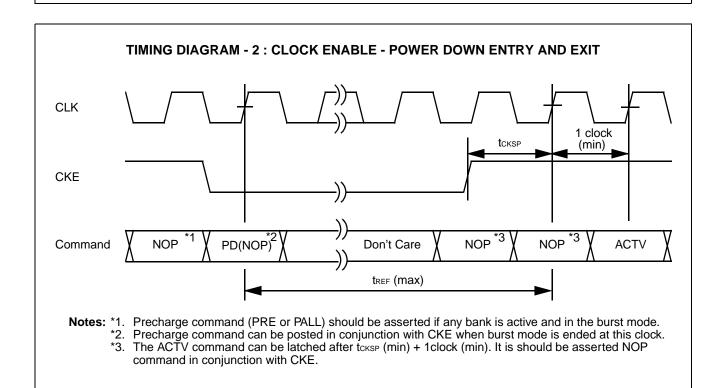


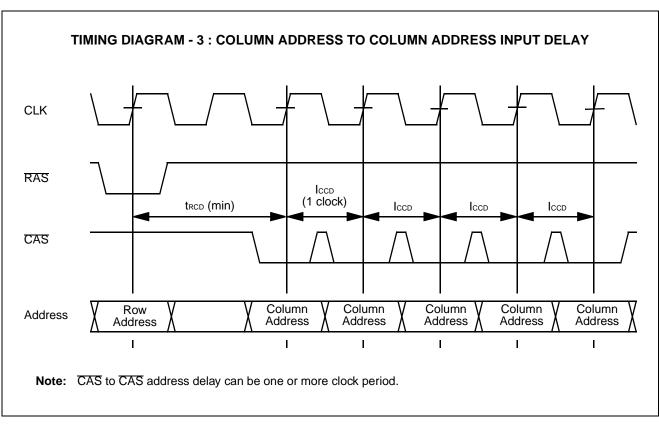


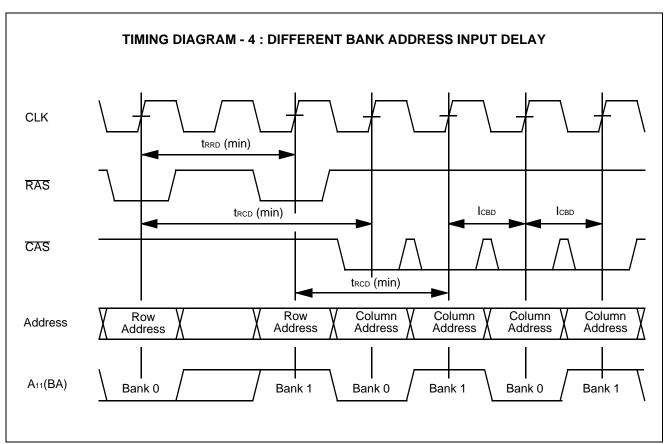
Notes: *1. The latency of CKE (ICKE) is one clock.

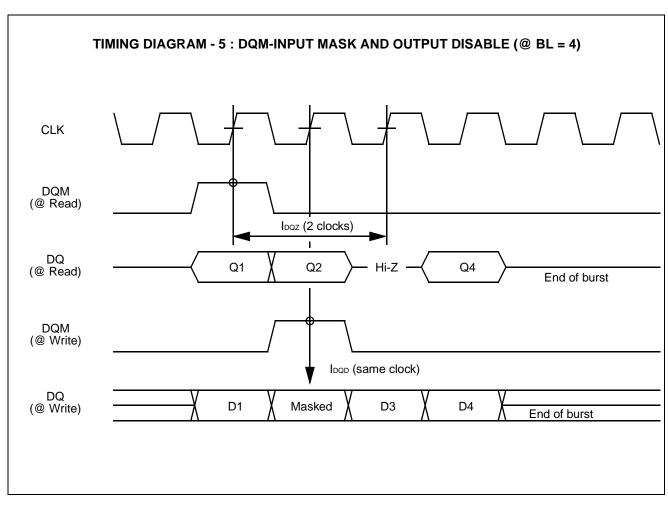
*2. During read mode, burst counter will not be incremented/decremented at the next clock of CSUS command. Output remain the same data.

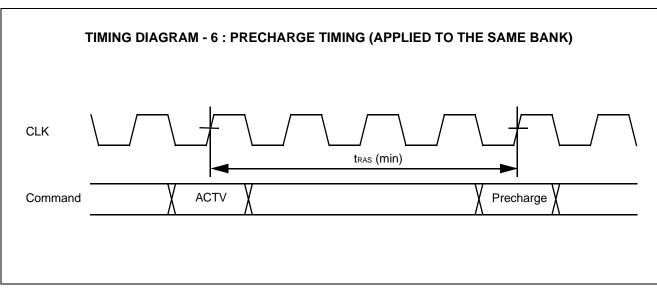
*3. During the write mode, data at the next clock of CSUS command is ignored.

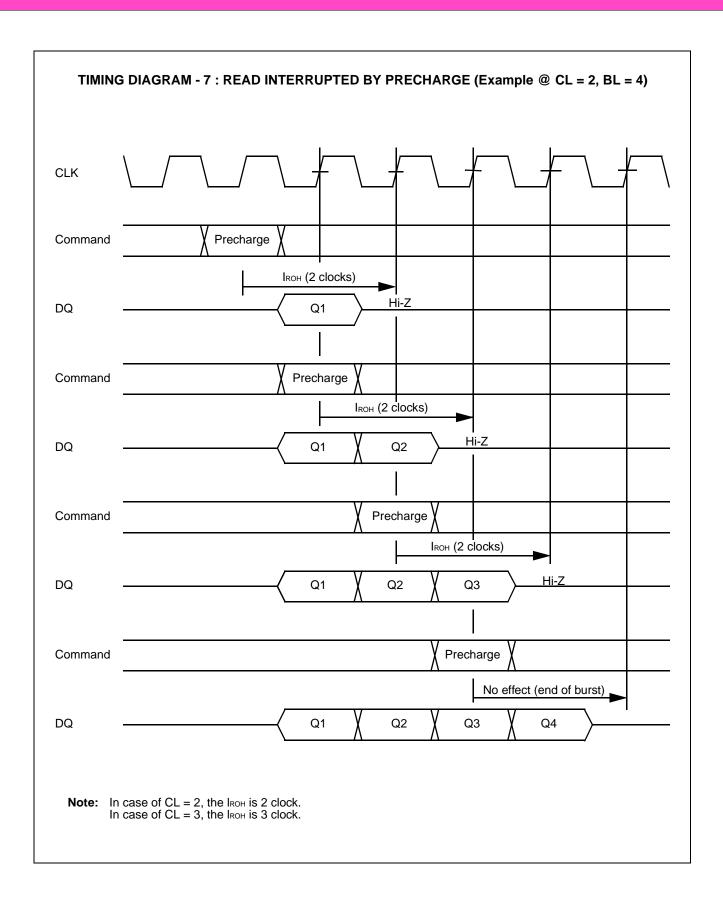


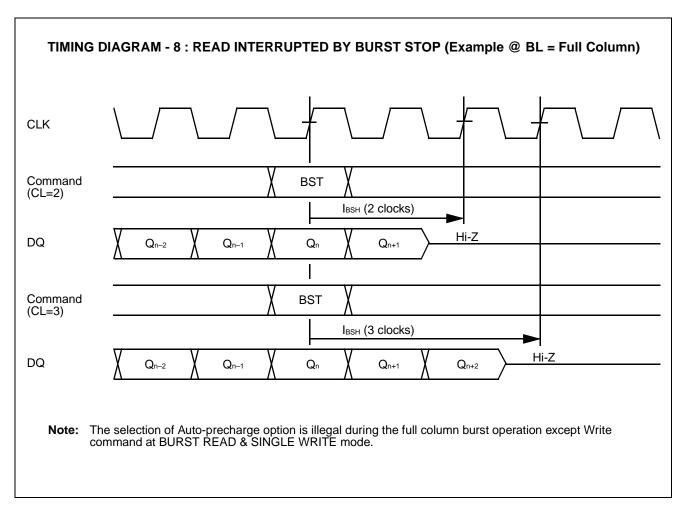


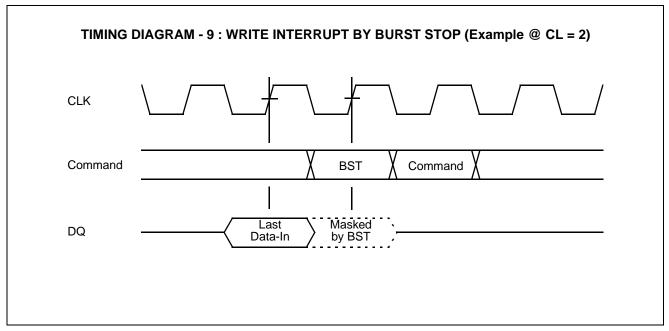


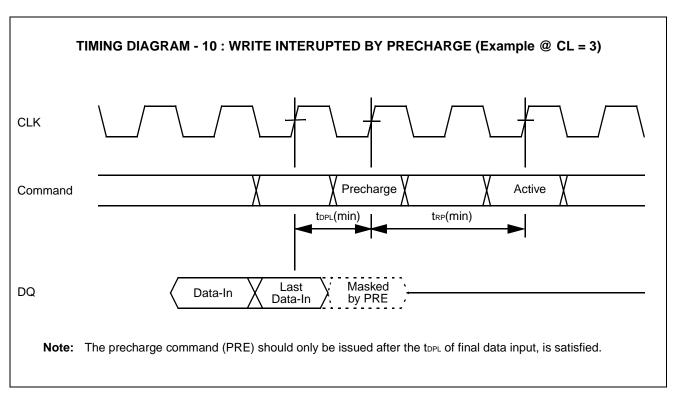


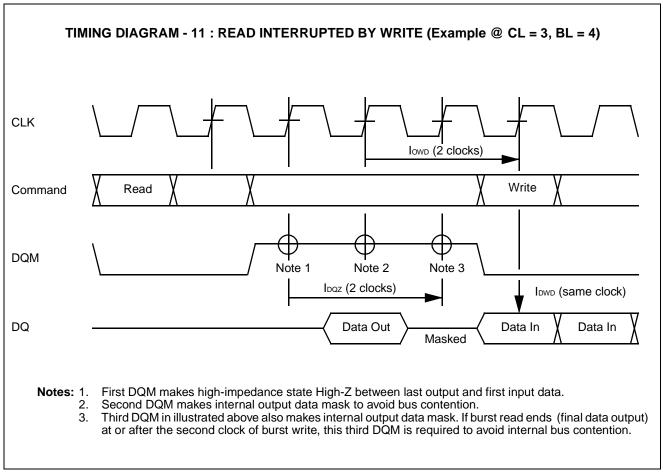


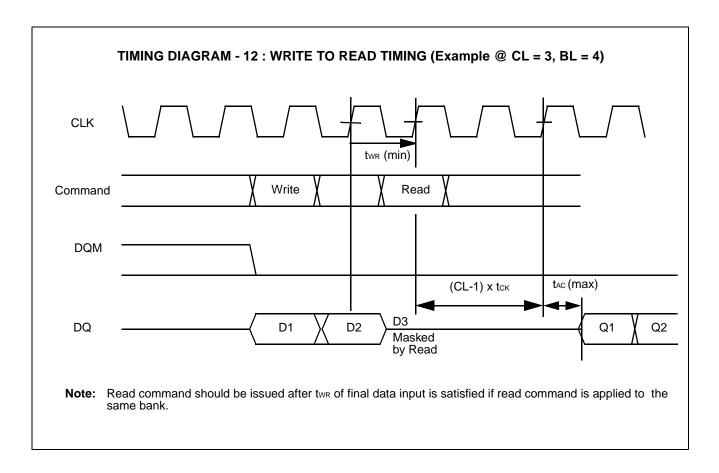


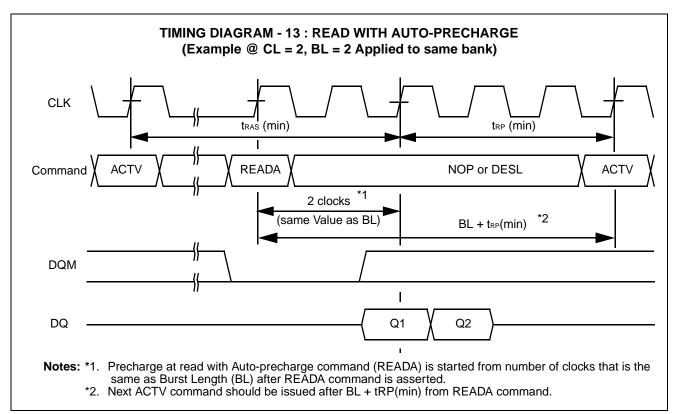


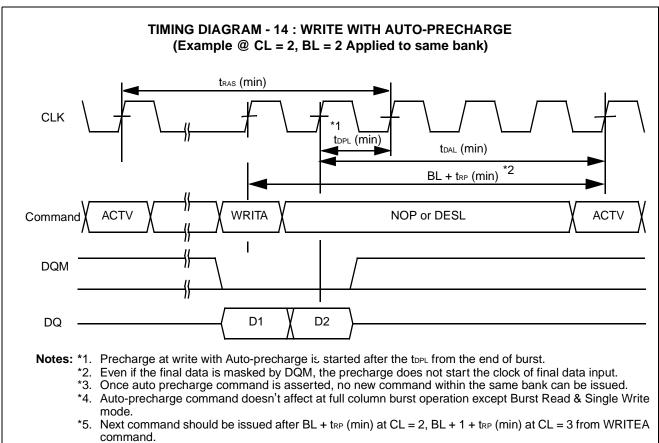


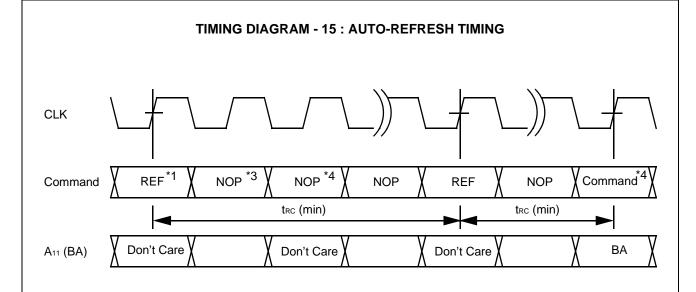






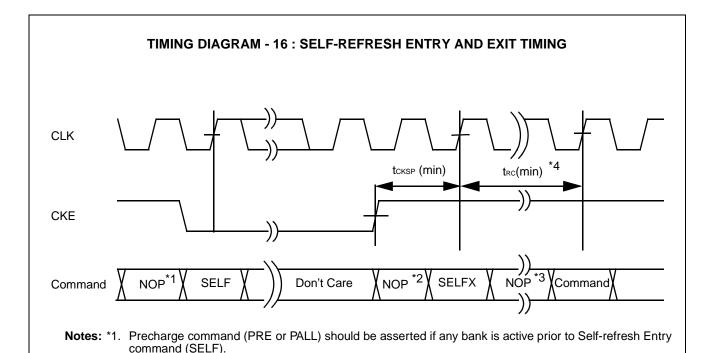






Notes: *1. All banks should be precharged prior to the first Auto-refresh command (REF).

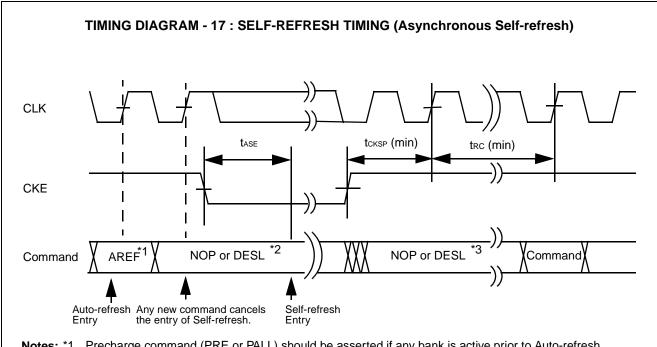
- *2. Bank select is ignored at REF command. The refresh address and bank select are selected by internal refresh counter.
- *3. Either NOP or DESL command should be asserted during trad and trac period while Auto-refresh mode.
 *4. Any activation command such as ACTV or MRS command other than REF command should be asserted after the from the last REF command.



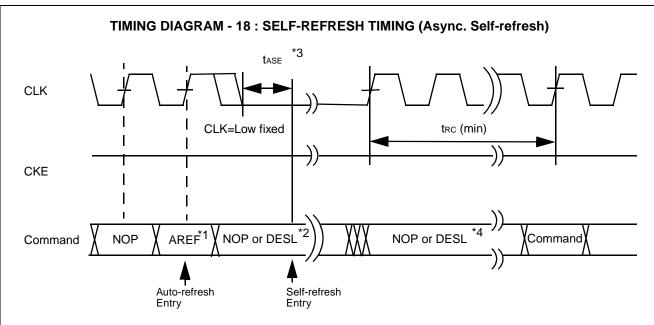
*2. The Self-refresh Exit command (SELFX) is latched after token (min). It is recommended to apply NOP command in conjunction with CKE. It is also recommended to apply minimum of 4 clocks to stabilize

external clock prior to SELFX command.

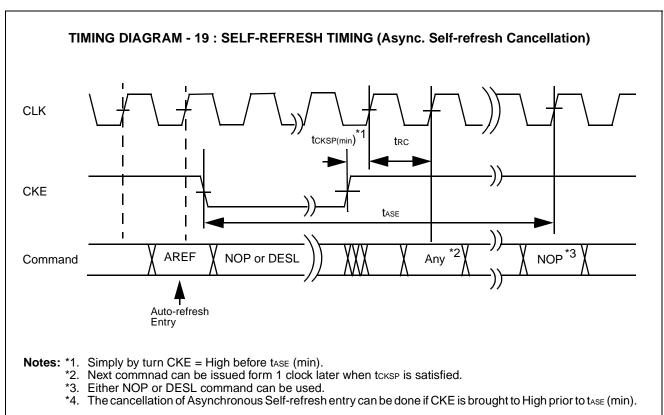
*3. Either NOP or DESL command can be used during tRC period. *4. CKE should be held High within trc(min) period after toksp

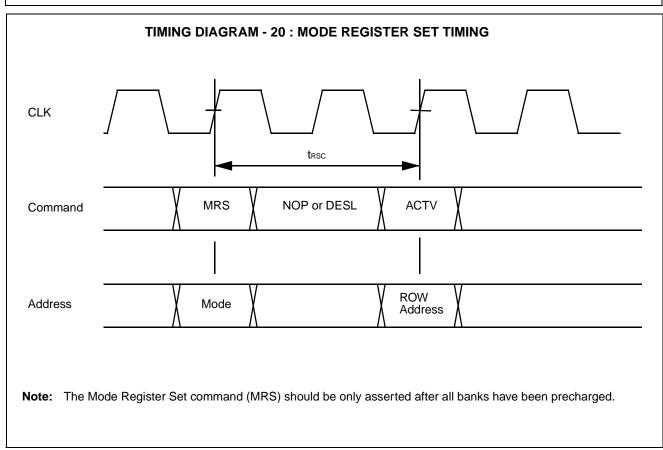


- **Notes:** *1. Precharge command (PRE or PALL) should be asserted if any bank is active prior to Auto-refresh command (AREF).
 - *2. Either NOP or DESL command can be used during the period. Applying any command before CKE is brought Low cancenls the entry of Asynchronous Self-refresh.
 - *3. Either NOP or DESL command can be used during tase period.

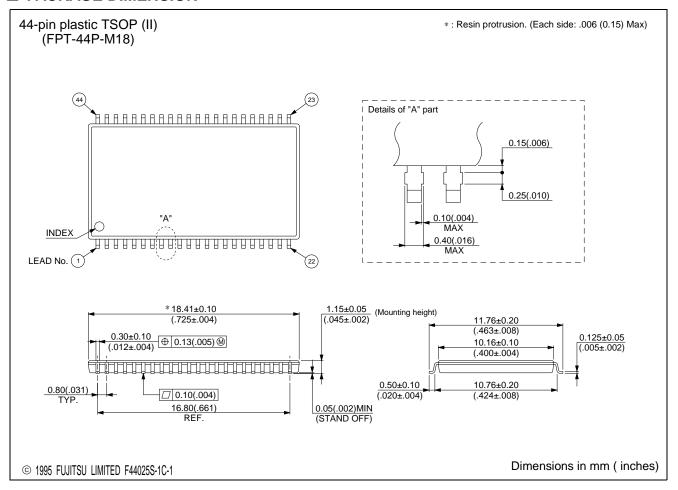


- **Notes:** *1. Precharge command (PRE or PALL) should be issued if any bank is active prior to Auto-refresh command (AREF).
 - *2. Either NOP or DESL command must be maintained.
 - *3. CLK must stop and be kept at Low in order to enter Asynchronous Self-refresh.
 - *4. Either NOP or DESL command can be used during trc period.





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